



High-or Low-Side Measurement, Bi-Directional CURRENT/POWER MONITOR with I²C™ Interface

Check for Samples: [INA226](#)

FEATURES

- SENSES BUS VOLTAGES FROM 0V TO +36V
- HIGH- OR LOW-SIDE SENSING
- REPORTS CURRENT, VOLTAGE, AND POWER
- HIGH ACCURACY:
 - 0.1% Gain Error (Max)
 - 10 μ V Offset (Max)
- CONFIGURABLE AVERAGING OPTIONS
- 16 PROGRAMMABLE ADDRESSES
- OPERATES FROM 2.7 TO 5.5V POWER SUPPLY
- MSOP-10 PACKAGE

APPLICATIONS

- SERVERS
- TELECOM EQUIPMENT
- COMPUTERS
- POWER MANAGEMENT
- BATTERY CHARGERS
- POWER SUPPLIES
- TEST EQUIPMENT

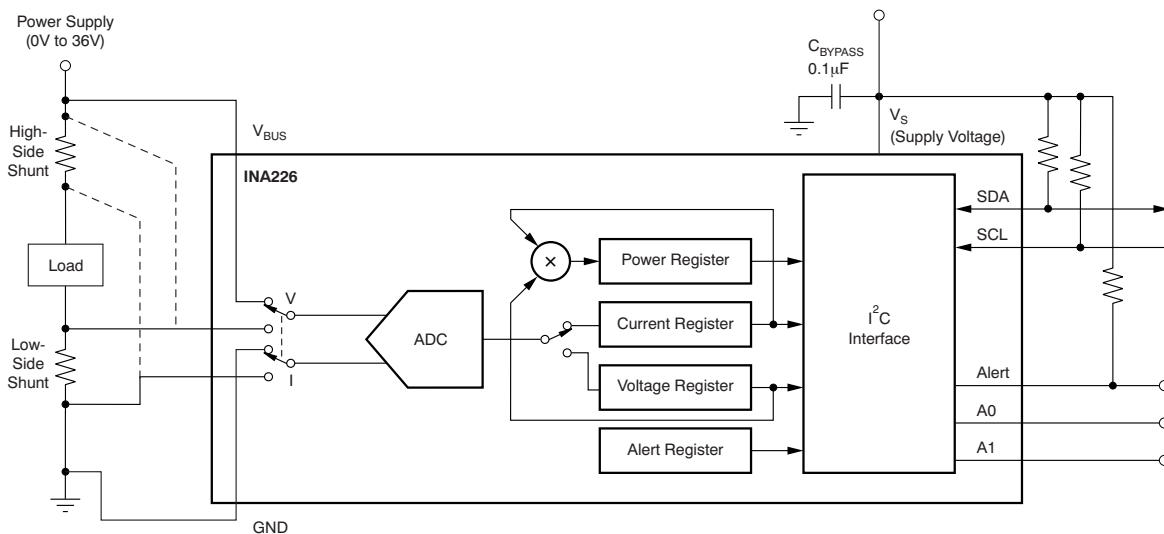
DESCRIPTION

The INA226 is a current shunt and power monitor with an I²C interface. The INA226 monitors both a shunt voltage drop and bus supply voltage. Programmable calibration value, conversion times, and averaging, combined with an internal multiplier, enable direct readouts of current in amperes and power in watts.

The INA226 senses current on buses that can vary from 0V to +36V, while the device obtains its power from a single +2.7V to +5.5V supply, drawing a typical of 330 μ A of supply current. The INA226 is specified over the operating temperature range of –40°C to +125°C. The I²C interface features 16 programmable addresses.

RELATED PRODUCTS

| DESCRIPTION | DEVICE |
|--|--|
| Current/Power Monitor with Watchdog, Peak-Hold, and Fast Comparator Functions | INA209 |
| Zerø-Drift, Low-Cost, Analog Current Shunt Monitor Series in Small Package | INA210 , INA211 , INA212 , INA213 , INA214 |
| Zerø-Drift, Bi-Directional Current Power Monitor with Two-Wire Interface | INA219 |
| High or Low Side, Bi-Directional Current/Power Monitor with Two-Wire Interface | INA220 |



High-or Low-Side Sensing



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This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

PACKAGING INFORMATION⁽¹⁾

| PRODUCT | PACKAGE-LEAD | PACKAGE DESIGNATOR | PACKAGE MARKING |
|-------------|--------------|--------------------|-----------------|
| INA226AIDGS | MSOP-10 | DGS | 226 |

- (1) For the most current package and ordering information see the Package Option Addendum at the end of this document, or see the [INA226 product folder](#) at www.ti.com.

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

Over operating free-air temperature range (unless otherwise noted).

| | | INA226 | UNIT |
|-----------------------------------|---|--------------------------|------|
| Supply Voltage, V_S | | 6 | V |
| Analog Inputs, VIN+, VIN– | Differential (VIN+) – (VIN–) ⁽²⁾ | –40 to +40 | V |
| | Common-Mode | –0.3 to +40 | V |
| SDA | | GND – 0.3 to +6 | V |
| SCL | | GND – 0.3 to $V_S + 0.3$ | V |
| Input Current Into Any Pin | | 5 | mA |
| Open-Drain Digital Output Current | | 10 | mA |
| Storage Temperature | | –65 to +150 | °C |
| Junction Temperature | | +150 | °C |
| ESD Ratings | Human Body Model (HBM) | 2500 | V |
| | Charged-Device Model (CDM) | 1000 | V |
| | Machine Model (MM) | 150 | V |

- (1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.
- (2) VIN+ and VIN– may have a differential voltage of –40V to +40V; however, the voltage at these pins must not exceed the range –0.3V to +40V.

ELECTRICAL CHARACTERISTICS: $V_S = +3.3V$
Boldface limits apply over the specified temperature range, $T_A = -40^{\circ}C$ to $+125^{\circ}C$.

 At $T_A = +25^{\circ}C$, $V_{IN+} = 12V$, $V_{SENSE} = (V_{IN+} - V_{IN-}) = 0mV$, $V_{BUS} = 12V$, unless otherwise noted.

| PARAMETER | CONDITIONS | INA226 | | | UNIT |
|--|--|--------------|-------------|--------------|-------------------|
| | | MIN | TYP | MAX | |
| INPUT | | | | | |
| Shunt voltage input range | | -81.9175 | | 81.92 | mV |
| Bus voltage input range ⁽¹⁾ | | 0 | | 36 | V |
| Common-mode rejection | CMRR $V_{IN+} = 0V$ to $+36V$ | 126 | 140 | | dB |
| Shunt offset voltage, RTI ⁽²⁾ | V_{OS} | | ± 2.5 | ± 10 | μV |
| vs Temperature | | | 0.02 | 0.1 | $\mu V/^{\circ}C$ |
| vs Power supply | PSRR $V_S = +2.7V$ to $+5.5V$ | | 2.5 | | $\mu V/V$ |
| Bus offset voltage, RTI ⁽²⁾ | V_{OS} | | ± 1.25 | ± 7.5 | mV |
| vs Temperature | | | 10 | 40 | $\mu V/^{\circ}C$ |
| vs Power supply | PSRR | | 0.5 | | mV/V |
| Input bias current | I_{IN+} , I_{IN-} | | 10 | | μA |
| V_{BUS} input impedance | | | 830 | | k Ω |
| Input leakage ⁽³⁾ | $(V_{IN+} - Pin) + (V_{IN-} - Pin)$, Power-down mode | | 0.1 | 0.5 | μA |
| DC ACCURACY | | | | | |
| ADC native resolution | | | 16 | | Bits |
| 1 LSB step size | Shunt voltage | | 2.5 | | μV |
| | Bus voltage | | 1.25 | | mV |
| Shunt voltage gain error | | | 0.02 | 0.1 | % |
| vs Temperature | | | 10 | 50 | ppm/ $^{\circ}C$ |
| Bus voltage gain error | | | 0.02 | 0.1 | % |
| vs Temperature | | | 10 | 50 | ppm/ $^{\circ}C$ |
| Differential nonlinearity | | | ± 0.1 | | LSB |
| ADC conversion time | CT bit = 000 | | 140 | 154 | μs |
| | CT bit = 001 | | 204 | 224 | μs |
| | CT bit = 010 | | 332 | 365 | μs |
| | CT bit = 011 | | 588 | 646 | μs |
| | CT bit = 100 | | 1.1 | 1.21 | ms |
| | CT bit = 101 | | 2.116 | 2.328 | ms |
| | CT bit = 110 | | 4.156 | 4.572 | ms |
| | CT bit = 111 | | 8.244 | 9.068 | ms |
| SMBus | | | | | |
| SMBus timeout ⁽⁴⁾ | | | 28 | 35 | ms |
| DIGITAL INPUT/OUTPUT | | | | | |
| Input capacitance | | | 3 | | pF |
| Leakage input current | $0 \leq V_{IN} \leq V_S$ | | 0.1 | 1 | μA |
| Input logic levels: | | | | | |
| V_{IH} | | 0.7(V_S) | | 6 | V |
| V_{IL} | | -0.5 | | 0.3(V_S) | V |
| Output logic level | | | | | |
| V_{OL} SDA, alert | $I_{OL} = 3mA$ | 0 | | 0.4 | V |
| Hysteresis | | | 500 | | mV |

- (1) While the input range is 36V, the full-scale range of the ADC scaling is 40.96V. See the [Basic ADC Functions](#) section. Do not apply more than 36V.
- (2) RTI = Referred-to-input.
- (3) Input leakage is positive (current flowing into the pin) for the conditions shown at the top of this table. Negative leakage currents can occur under different input conditions.
- (4) SMBus timeout in the INA226 resets the interface any time SCL is low for more than 28ms.

ELECTRICAL CHARACTERISTICS: $V_S = +3.3V$ (continued)

Boldface limits apply over the specified temperature range, $T_A = -40^\circ\text{C}$ to $+125^\circ\text{C}$.

At $T_A = +25^\circ\text{C}$, $V_{IN+} = 12V$, $V_{SENSE} = (V_{IN+} - V_{IN-}) = 0mV$, $V_{BUS} = 12V$, unless otherwise noted.

| PARAMETER | CONDITIONS | INA226 | | | UNIT |
|------------------------------------|------------|--------|-----|------|------------------|
| | | MIN | TYP | MAX | |
| POWER SUPPLY | | | | | |
| Operating supply range | | +2.7 | | +5.5 | V |
| Quiescent current | | | 330 | 420 | μA |
| Quiescent current, power-down mode | | | 0.5 | 2 | μA |
| Power-on reset threshold | | | 2 | | V |
| TEMPERATURE RANGE | | | | | |
| Specified range | | -40 | | +125 | $^\circ\text{C}$ |

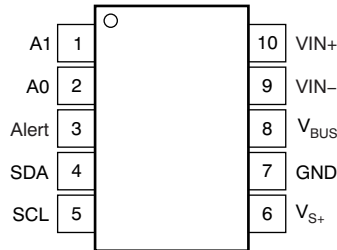
THERMAL INFORMATION

| THERMAL METRIC ⁽¹⁾ | | INA226 | UNITS |
|-------------------------------|--|---------|---------------------------|
| | | DGS | |
| | | 10 PINS | |
| θ_{JA} | Junction-to-ambient thermal resistance | 171.4 | $^\circ\text{C}/\text{W}$ |
| θ_{JCTop} | Junction-to-case (top) thermal resistance | 42.9 | |
| θ_{JB} | Junction-to-board thermal resistance | 91.8 | |
| ψ_{JT} | Junction-to-top characterization parameter | 1.5 | |
| ψ_{JB} | Junction-to-board characterization parameter | 90.2 | |
| θ_{JCbott} | Junction-to-case (bottom) thermal resistance | n/a | |

(1) For more information about traditional and new thermal metrics, see the *IC Package Thermal Metrics* application report, [SPRA953](#).

PIN CONFIGURATIONS

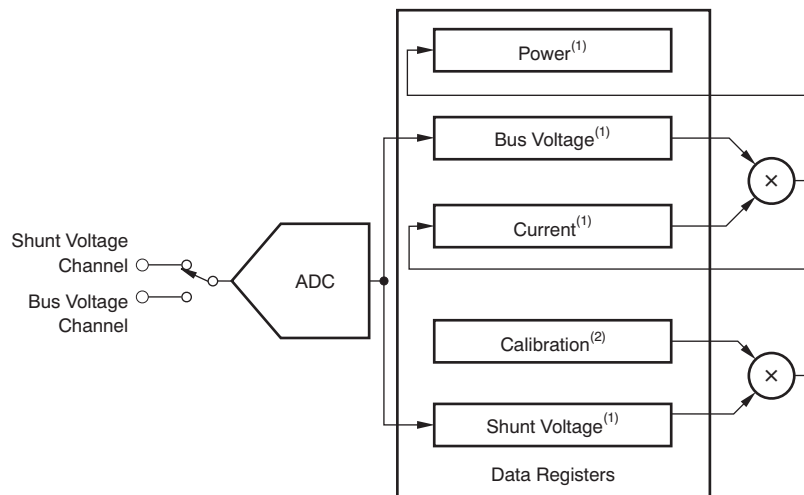
DGS PACKAGE
MSOP-10
(Top View)



PIN DESCRIPTIONS

| MSOP-10 (DGS) | | DESCRIPTION |
|---------------|-----------|---|
| PIN NO | NAME | |
| 1 | A1 | Address pin. Connect to GND, SCL, SDA, or V_S . Table 7 shows pin settings and corresponding addresses. |
| 2 | A0 | Address pin. Connect to GND, SCL, SDA, or V_S . Table 7 shows pin settings and corresponding addresses. |
| 3 | Alert | Multi-functional alert, open-drain output. |
| 4 | SDA | Serial bus data line, open-drain input/output. |
| 5 | SCL | Serial bus clock line, open-drain input. |
| 6 | V_{S+} | Power supply, 2.7V to 5.5V. |
| 7 | GND | Ground. |
| 8 | V_{BUS} | Bus voltage input. |
| 9 | VIN- | Negative differential shunt voltage. Connect to negative side of shunt resistor. |
| 10 | VIN+ | Positive differential shunt voltage. Connect to positive side of shunt resistor. |

REGISTER BLOCK DIAGRAM



- (1) Read-only
- (2) Read/write

Figure 1. INA226 Register Block Diagram

TYPICAL CHARACTERISTICS

At $T_A = +25^\circ\text{C}$, $V_S = +3.3\text{V}$, $V_{IN+} = 12\text{V}$, $V_{SENSE} = (V_{IN+} - V_{IN-}) = 0\text{mV}$, $V_{BUS} = 12\text{V}$, unless otherwise noted.

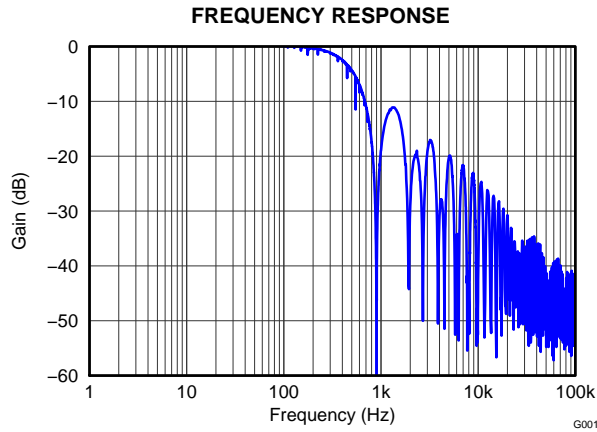


Figure 2.

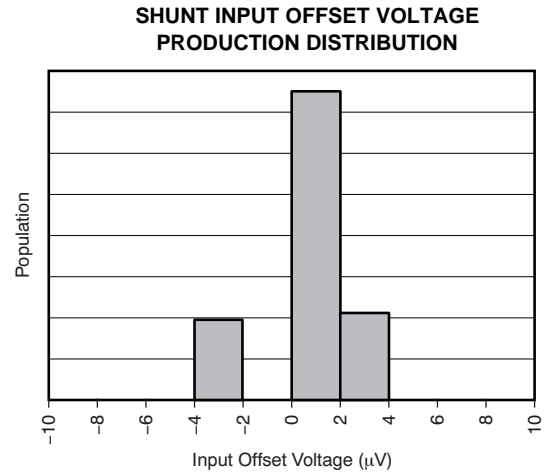


Figure 3.

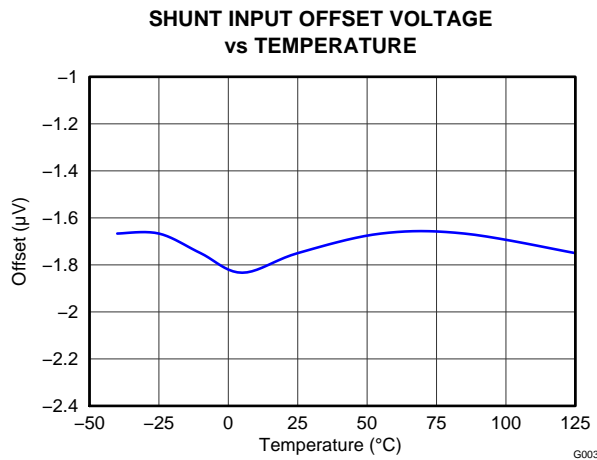


Figure 4.

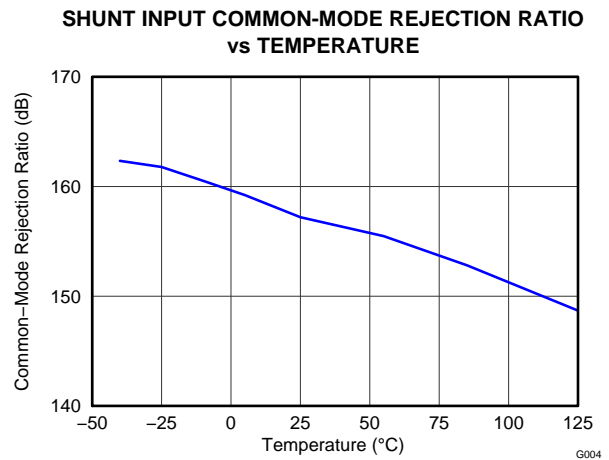


Figure 5.

SHUNT INPUT GAIN ERROR PRODUCTION DISTRIBUTION

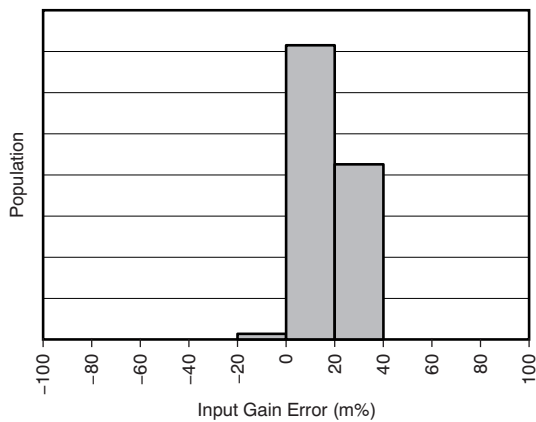


Figure 6.

SHUNT INPUT GAIN ERROR vs TEMPERATURE

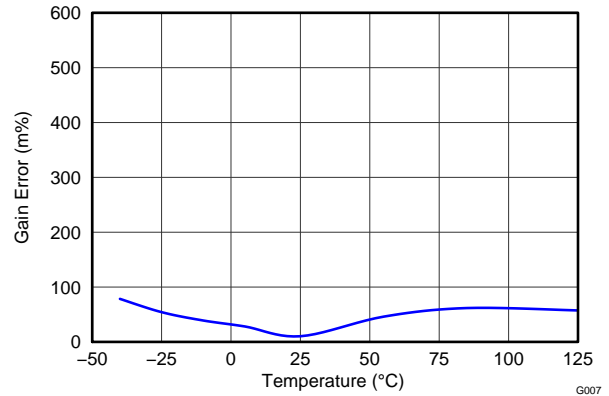


Figure 7.

TYPICAL CHARACTERISTICS (continued)

At $T_A = +25^\circ\text{C}$, $V_S = +3.3\text{V}$, $V_{IN+} = 12\text{V}$, $V_{SENSE} = (V_{IN+} - V_{IN-}) = 0\text{mV}$, $V_{BUS} = 12\text{V}$, unless otherwise noted.

SHUNT INPUT GAIN ERROR vs COMMON-MODE VOLTAGE

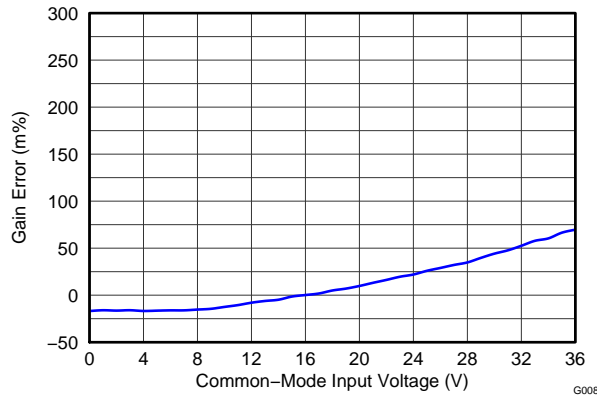


Figure 8.

BUS INPUT OFFSET VOLTAGE PRODUCTION DISTRIBUTION

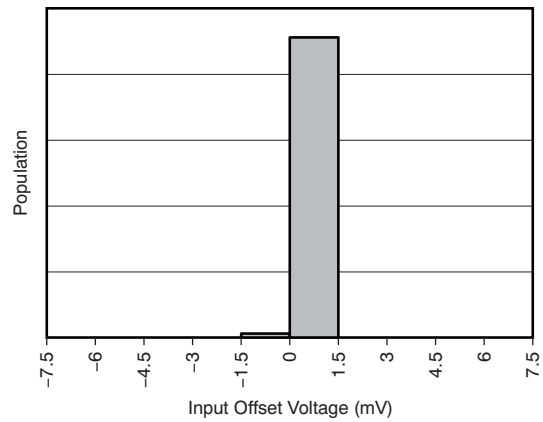


Figure 9.

BUS INPUT OFFSET VOLTAGE vs TEMPERATURE

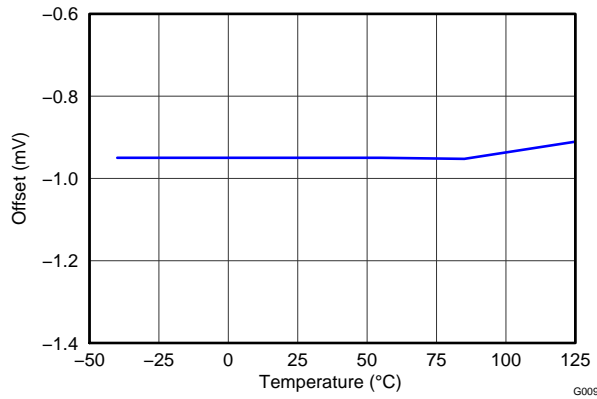


Figure 10.

BUS INPUT GAIN ERROR PRODUCTION DISTRIBUTION

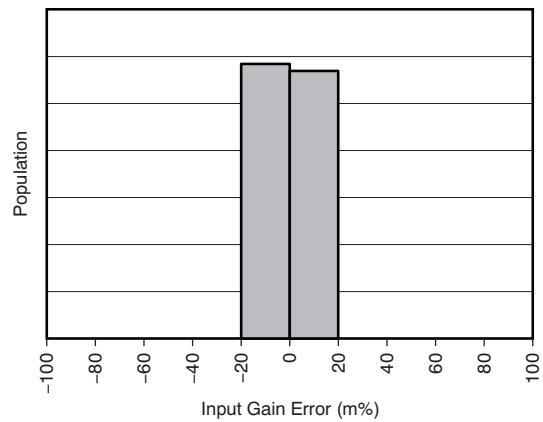


Figure 11.

BUS INPUT GAIN ERROR vs TEMPERATURE

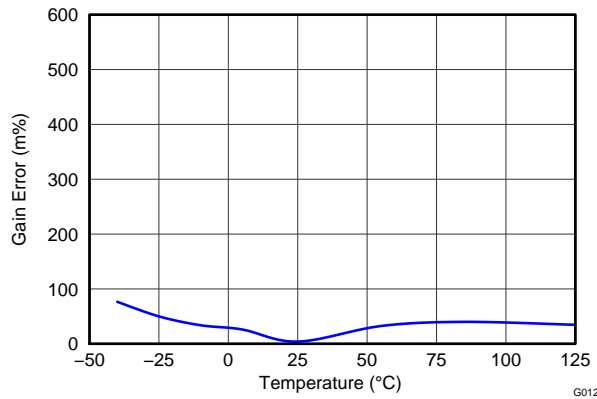


Figure 12.

INPUT BIAS CURRENT vs COMMON-MODE VOLTAGE

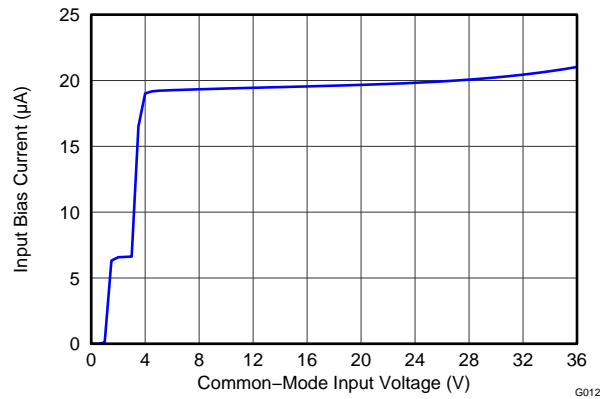


Figure 13.

TYPICAL CHARACTERISTICS (continued)

At $T_A = +25^\circ\text{C}$, $V_S = +3.3\text{V}$, $V_{IN+} = 12\text{V}$, $V_{SENSE} = (V_{IN+} - V_{IN-}) = 0\text{mV}$, $V_{BUS} = 12\text{V}$, unless otherwise noted.

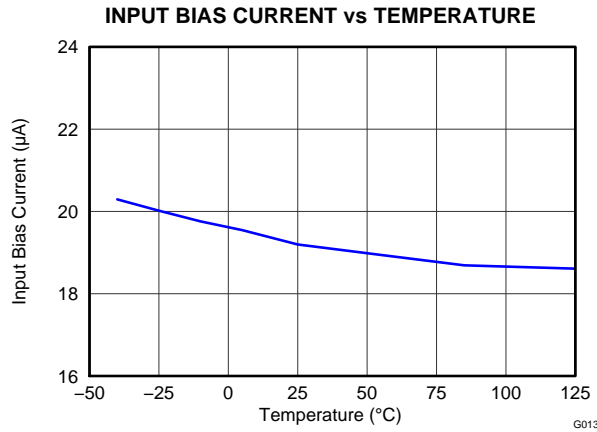


Figure 14.

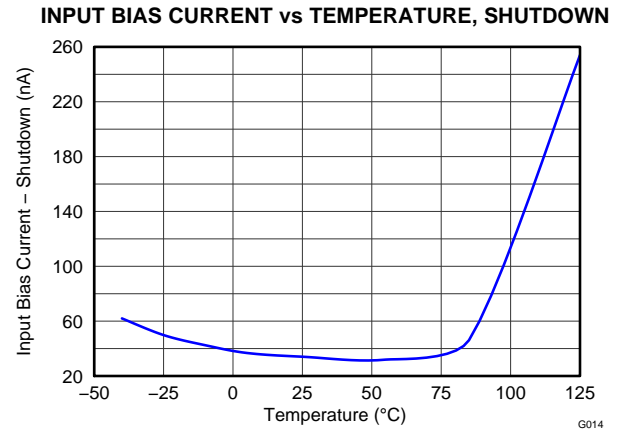


Figure 15.

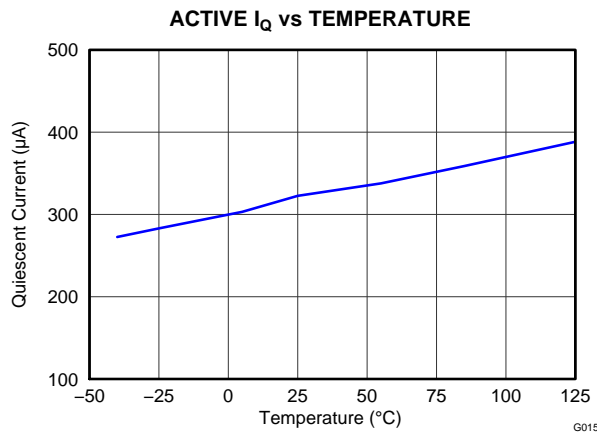


Figure 16.

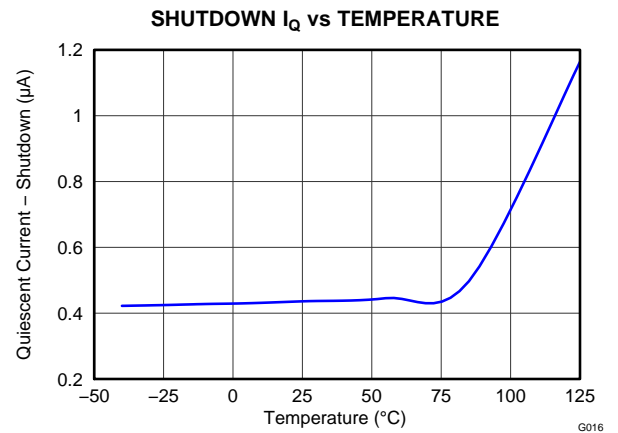


Figure 17.

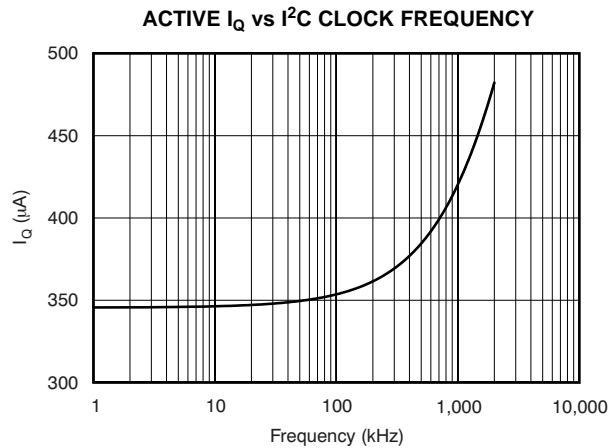


Figure 18.

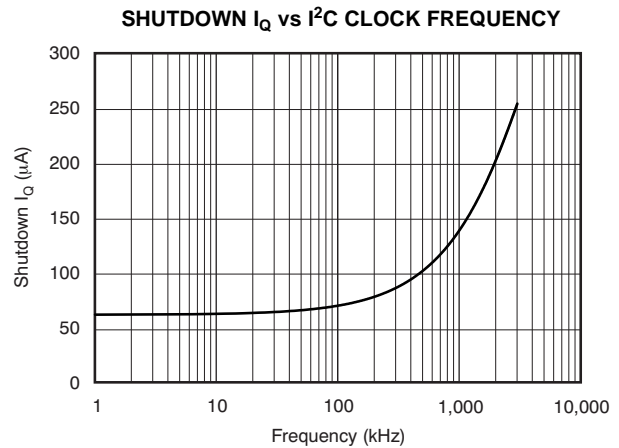


Figure 19.

APPLICATION INFORMATION

The INA226 is a digital current shunt monitor with an I²C- and SMBus-compatible interface. It provides digital current, voltage, and power readings necessary for accurate decision-making in precisely-controlled systems. Programmable registers allow flexible configuration for measurement resolution as well as continuous-versus-triggered operation. Detailed register information appears at the end of this data sheet, beginning with [Table 2](#). See the [Register Block Diagram](#) for a block diagram of the INA226.

INA226 TYPICAL APPLICATION

The [front-page figure](#) shows a typical application circuit for the INA226. Use a 0.1µF ceramic capacitor for power-supply bypassing, placed as closely as possible to the supply and ground pins.

BASIC ADC FUNCTIONS

The INA226 performs two measurements on the power-supply bus of interest. The voltage developed from the load current that flows through a shunt resistor creates a shunt voltage that is measured at the VIN+ and VIN– pins. The device can also measure the power supply bus voltage by connecting this voltage to the V_{BUS} pin. The differential shunt voltage is measured with respect to the VIN– pin while the bus voltage is measured with respect to ground.

The INA226 is typically powered by a separate supply that can range from 2.7V to 5.5V. The bus that is being monitored can range in voltage from 0V to 36V. It is important to note here that based on the fixed 1.25mV LSB for the bus voltage register that a full-scale register would result in a 40.96V value. **The actual voltage that is applied to the input pins of the INA226 should not exceed 36V.** There are no special considerations for power-supply sequencing because the common-mode input range and power-supply voltage are independent of each other; therefore, the bus voltage can be present with the supply voltage off, and vice-versa.

As noted, the INA226 takes two measurements, shunt voltage and bus voltage. It then converts these measurements to current, based on the Calibration Register value, and then calculates power. Refer to the [Configure/Measure/Calculate Example](#) section for additional information on programming the Calibration Register.

The INA226 has two operating modes, continuous and triggered, that determine how the ADC operates following these conversions. When the INA226 is in the normal operating mode (that is, MODE bits of the Configuration Register are set to '111'), it continuously converts a shunt voltage reading followed by a bus voltage reading. After the shunt voltage reading, the current value is calculated (based on [Equation 3](#)). This current value is then used to calculate the power result (using [Equation 4](#)). These values are subsequently stored in an accumulator, and the measurement/calculation sequence repeats until the number of averages set in the Configuration Register is reached. Following every sequence, the present set of values measured and calculated are appended to previously collected values. Once all of the averaging has been completed, the final values for shunt voltage, bus voltage, current, and power are updated in the corresponding registers that can then be read. These values remain in the data output registers until they are replaced by the next fully completed conversion results. Reading the data output registers does not affect a conversion in progress.

The Mode control in the Configuration Register also permits selecting modes to convert only the shunt voltage or the bus voltage in order to further allow the user to configure the monitoring function to fit the specific application requirements.

All current and power calculations are performed in the background and do not contribute to conversion time.

In triggered mode, writing any of the triggered convert modes into the Configuration Register (that is, MODE bits of the Configuration Register are set to '001', '010', or '011') triggers a single-shot conversion. This action produces a single set of measurements; thus, to trigger another single-shot conversion, the Configuration Register must be written to a second time, even if the mode does not change.

In addition to the two operating modes (continuous and triggered), the INA226 also has a power-down mode that reduces the quiescent current and turns off current into the INA226 inputs, reducing the impact of supply drain when the device is not being used. Full recovery from power-down mode requires 40ms. The registers of the INA226 can be written to and read from while the device is in power-down mode. The device remains in power-down mode until one of the active modes settings are written into the Configuration Register.

Although the INA226 can be read at any time, and the data from the last conversion remain available, the Conversion Ready Flag bit (Mask/Enable Register, CVRF bit) is provided to help coordinate one-shot or triggered conversions. The Conversion Ready Flag bit is set after all conversions, averaging, and multiplication operations are complete.

The Conversion Ready Flag bit clears under these conditions:

1. Writing to the Configuration Register, except when configuring the MODE bits for power-down mode; or
2. Reading the Status Register.

Power Calculation

The Current and Power are calculated following shunt voltage and bus voltage measurements as shown in Figure 20. Current is calculated following a shunt voltage measurement based on the value set in the Calibration Register. If there is no value loaded into the Calibration Register, the current value stored is zero. Power is calculated following the bus voltage measurement based on the previous current calculation and bus voltage measurement. If there is no value loaded in the Calibration Register, the power value stored is also zero. Again, these calculations are performed in the background and do not add to the overall conversion time. These current and power values are considered intermediate results (unless the averaging is set to 1) and are stored in an internal accumulation register, not the corresponding output registers. Following every measured sample, the newly-calculated values for current and power are appended to this accumulation register until all of the samples have been measured and averaged based on the number of averages set in the Configuration Register.

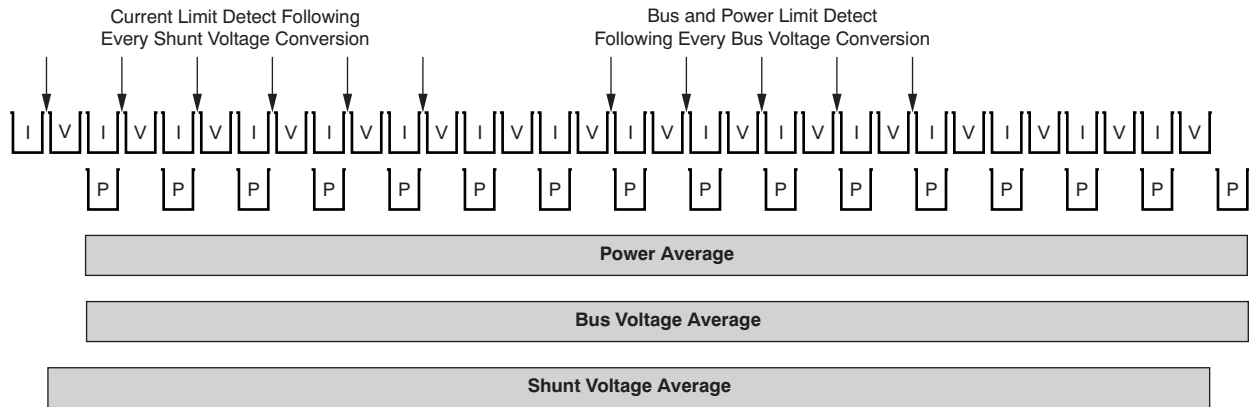


Figure 20. Power Calculation Scheme

In addition to the current and power accumulating after every sample, the shunt and bus voltage measurements are also collected. Once all of the samples have been measured and the corresponding current and power calculations have been made, the accumulated average for each of these parameters is then loaded to the corresponding output registers, where they can then be read.

Averaging and Conversion Time Considerations

The INA226 has programmable conversion times for both the shunt voltage and bus voltage measurements. The conversion times for these measurements can be selected from as fast as 140µs to as long as 8.244ms. The conversion time settings, along with the programmable averaging mode, allow the INA226 to be configured to optimize the available timing requirements in a given application. For example, if a system requires that data be read every 5ms, the INA226 could be configured with the conversion times set to 588µs and the averaging mode set to 4. This configuration results in the data updating approximately every 4.7ms. The INA226 could also be configured with a different conversion time setting for the shunt and bus voltage measurements. This type of approach is common in applications where the bus voltage tends to be relatively stable. This situation can allow for the time focused on the bus voltage measurement to be reduced relative to the shunt voltage measurement. The shunt voltage conversion time could be set to 4.156ms with the bus voltage conversion time set to 588µs, with the averaging mode set to 1. This configuration also results in data updating approximately every 4.7ms.

There are trade-offs associated with the settings for conversion time and the averaging mode used. The averaging feature can significantly improve the measurement accuracy by effectively filtering the signal. This approach allows the INA226 to reduce any noise in the measurement that may be caused by noise coupling into the signal. A greater number of averages enables the INA226 to be more effective in reducing the noise component of the measurement.

The conversion times selected can also have an impact on the measurement accuracy. This effect can be seen in [Figure 21](#). Multiple conversion times are shown here to illustrate the impact of noise on the measurement. In order to achieve the highest accuracy measurement possible, a combination of the longest allowable conversion times and highest number of averages should be used, based on the timing requirements of the system.

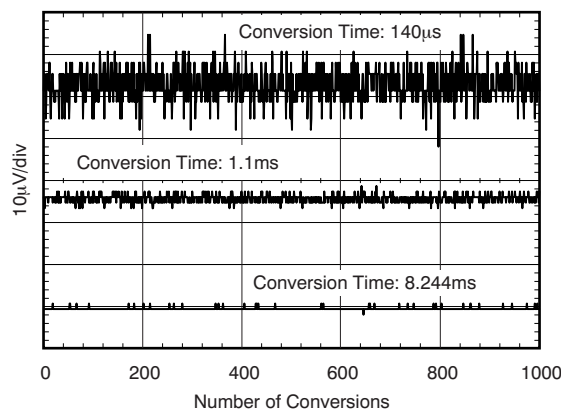


Figure 21. Noise vs Conversion Time

Filtering and Input Considerations

Measuring current is often noisy, and such noise can be difficult to define. The INA226 offers several options for filtering by allowing the conversion times and number of averages to be selected independently in the Configuration Register. The conversion times can be set independently for the shunt voltage and bus voltage measurements to allow added flexibility in configuring the monitoring of the power-supply bus.

The internal ADC is based on a delta-sigma ($\Delta\Sigma$) front-end with a 500kHz ($\pm 30\%$) typical sampling rate. This architecture has good inherent noise rejection; however, transients that occur at or very close to the sampling rate harmonics can cause problems. Because these signals are at 1MHz and higher, they can be managed by incorporating filtering at the input of the INA226. The high frequency enables the use of low-value series resistors on the filter with negligible effects on measurement accuracy. In general, filtering the INA226 input is only necessary if there are transients at exact harmonics of the 500kHz ($\pm 30\%$) sampling rate (greater than 1MHz). Filter using the lowest possible series resistance (typically 10 Ω or less) and a ceramic capacitor. Recommended values for this capacitor are 0.1 μF to 1.0 μF . Figure 22 shows the INA226 with an additional filter added at the input.

Overload conditions are another consideration for the INA226 inputs. The INA226 inputs are specified to tolerate 40V across the inputs. A large differential scenario might be a short to ground on the load side of the shunt. This type of event can result in full power-supply voltage across the shunt (as long the power supply or energy storage capacitors support it). Keep in mind that removing a short to ground can result in inductive kickbacks that could exceed the 40V differential and common-mode rating of the INA226. Inductive kickback voltages are best controlled by zener-type transient-absorbing devices (commonly called *transzorb*s) combined with sufficient energy storage capacitance.

In applications that do not have large energy storage electrolytics on one or both sides of the shunt, an input overstress condition may result from an excessive dV/dt of the voltage applied to the input. A hard physical short is the most likely cause of this event, particularly in applications with no large electrolytics present. This problem occurs because an excessive dV/dt can activate the ESD protection in the INA226 in systems where large currents are available. Testing has demonstrated that the addition of 10 Ω resistors in series with each input of the INA226 sufficiently protect the inputs against this dV/dt failure up to the 40V rating of the INA226. Selecting these resistors in the range noted has minimal effect on accuracy.

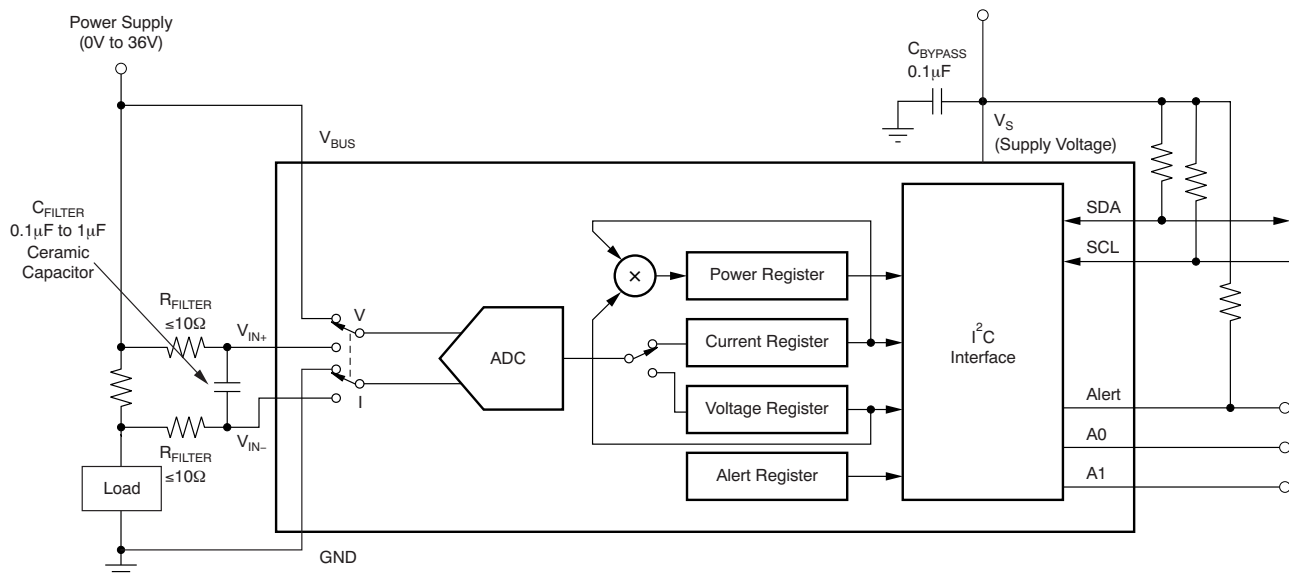


Figure 22. INA226 with Input Filtering

ALERT PIN

The INA226 has a single Alert Limit register, 07h, that allows the Alert pin to be programmed to respond to a single user-defined event or to a conversion ready notification if desired. The Mask/Enable Register allows the user to select from one of the five available functions to monitor and/or set the conversion ready bit to control the response of the Alert pin. Based on the function being monitored, the user would then enter a value into the Alert Limit Register to set the corresponding threshold value that asserts the Alert pin.

The Alert pin allows for one of several available alert functions to be monitored to determine if a user-defined threshold has been exceeded. The five alert functions that can be monitored are:

- Shunt Voltage Over Limit (SOL)
- Shunt Voltage Under Limit (SUL)
- Bus Voltage Over Limit (BOL)
- Bus Voltage Under Limit (BUL)
- Power Over Limit (POL)

The Alert pin is an open-drain output. This pin is asserted when the alert function selected in the Mask/Enable register exceeds the value programmed into the Alert Limit register. Only one of these alert functions can be enabled and monitored at a time. If multiple alert functions are enabled, the selected function in the highest significant bit position takes priority and responds to the Alert Limit register value. For example, if the Shunt Voltage Over Limit and the Shunt Voltage Under Limit are both selected, the Alert pin asserts when the Shunt Voltage Over Limit Register exceeds the value in the Alert Limit register.

The Conversion Ready state of the device can also be monitored at the Alert pin to inform the user when the device has completed the previous conversion and is ready to begin a new conversion. Conversion Ready can be monitored at the Alert pin along with one of the alert functions. If an alert function and the Conversion Ready are both enabled to be monitored at the Alert pin, after the Alert pin is asserted, the Mask/Enable register must be read following the alert to determine the source of the alert. By reading the Conversion Ready Flag (CVRF), bit D3, and the Alert Function Flag (AFF), bit D4 in the Mask/Enable register, the source of the alert can be determined. If the conversion ready feature is not desired, and the CNVR bit is not set, the Alert pin only responds to an exceeded alert limit based on the alert function enabled.

If the Alert function is not used, the Alert pin can be left floating without impacting the operation of the device.

Refer to [Figure 20](#) to see the relative timing of when the value in the Alert Limit Register is compared to the corresponding converted value. For example, if the alert function that is enabled is Shunt Voltage Over Limit (SOL), following every shunt voltage conversion the value in the Alert Limit Register is compared to the measured shunt voltage to determine if the measurements has exceeded the programmed limit. The AFF, bit 4 of the Mask/Enable Register, asserts high any time the measured voltage exceeds the value programmed into the Alert Limit Register. In addition to the AFF being asserted, the Alert pin is asserted based on the Alert Polarity Bit (APOL, bit 1 of the Mask/Enable Register). If the Alert Latch is enabled, the AFF and Alert pin remain asserted until either the Configuration Register is written to or the Mask/Enable Register is read.

The Bus Voltage alert functions compare the measured bus voltage to the Alert Limit Register following every bus voltage conversion and assert the AFF bit and Alert pins if the limit threshold is exceeded.

The Power Over Limit alert function is also compared to the calculated power value following every bus voltage measurement conversion and asserts the AFF bit and Alert pins if the limit threshold is exceeded.

PROGRAMMING THE INA226

An important aspect of the INA226 is that it does not necessarily measure current or power. The INA226 measures both the differential voltage applied between the VIN+ and VIN- input pins and the voltage applied to the VBUS pin. In order for the INA226 to report both current and power values, the user must program the resolution of the Current Register and the value of the shunt resistor present in the application to develop the differential voltage applied between the input pins. The Power Register is internally set to be 25 times the programmed Current_LSB. Both the Current_LSB and shunt resistor value are used in the calculation of the Calibration Register value the INA226 uses to calculate the corresponding current and power values based on the measured shunt and bus voltages.

The Calibration Register is calculated based on [Equation 1](#). This equation includes the term Current_LSB. This is the programmed value for the LSB for the Current Register. This is the value the user will use to convert the value in the Current Register to the actual current in amps. The highest resolution for the Current Register can be obtained by using the smallest allowable Current_LSB based on the maximum expected current as shown in [Equation 2](#). While this value will yield the highest resolution, it is common to select a value for the Current_LSB to the nearest round number above this value to simplify the conversion of the Current Register and Power Register to amps and watts respectively. The RSHUNT term is the value of the external shunt used to develop the differential voltage across the input pins. The 0.00512 value in [Equation 1](#) is an internal fixed value used to ensure scaling is maintained properly.

$$CAL = \frac{0.00512}{Current_LSB \cdot R_{SHUNT}} \quad (1)$$

$$Current_LSB = \frac{Maximum\ Expected\ Current}{2^{15}} \quad (2)$$

Once the Calibration Register has been programmed, the Current Register and Power Register will be updated accordingly based on the corresponding shunt voltage and bus voltage measurements. Until the Calibration Register is programmed, the Current and Power Registers remain at zero.

CONFIGURE/MEASURE/CALCULATE EXAMPLE

In this example, shown in [Figure 23](#), a nominal 10A load creates a differential voltage of 20mV across a 2mΩ shunt resistor. The bus voltage for the INA226 is measured at the external V_{BUS} input pin, which in this example is connected to the VIN– pin to measure the voltage level delivered to the load. For this example, the V_{BUS} pin measures less than 12V because the voltage at the VIN– pin is 11.98V as a result of the voltage drop across the shunt resistor.

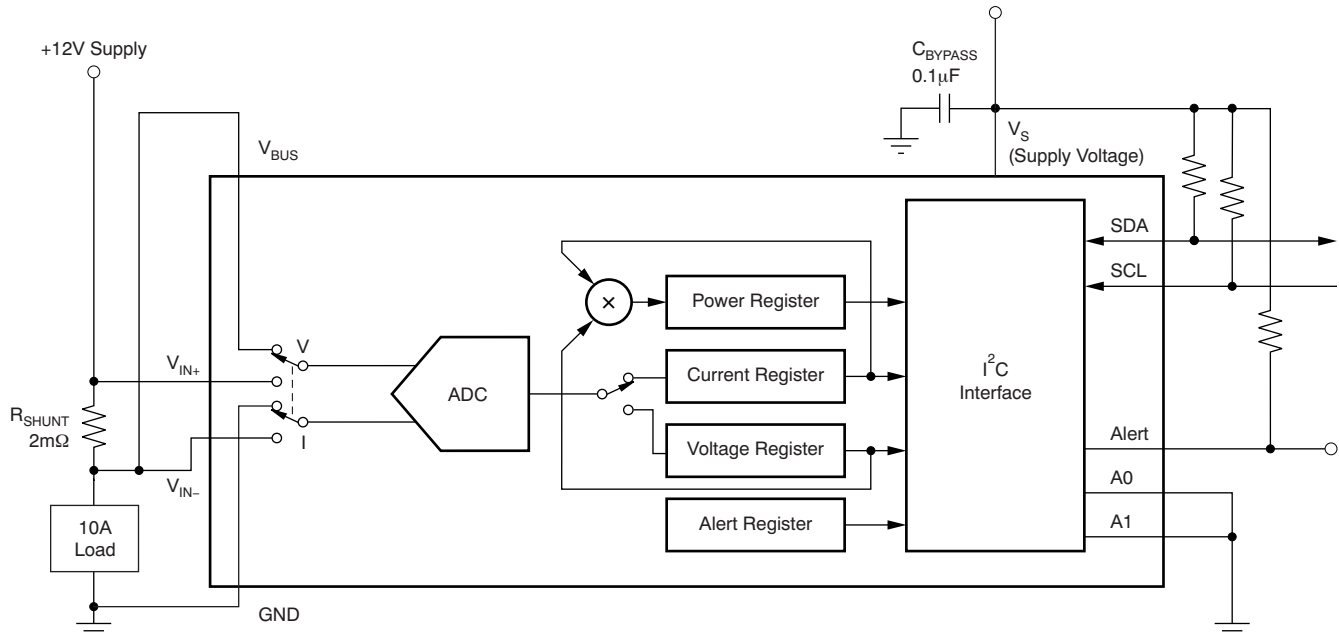


Figure 23. Example Circuit Configuration

For this example, assuming a maximum expected current of 15A, the Current_LSB is calculated to be 457.7μA/bit using [Equation 2](#). Using a value for the Current_LSB of 500μA/Bit or 1mA/Bit would significantly simplify the conversion from the Current Register and Power Register to amps and watts. For this example, a value of 1mA/bit was chosen for the current LSB. Using this value for the Current_LSB does trade a small amount of resolution for having a simpler conversion process on the user side. Using [Equation 1](#) in this example with a current LSB of 1mA/bit and a shunt resistor of 2mΩ results in a Calibration Register value of 2560, or A00h.

The Current Register (04h) is then calculated by multiplying the decimal value of the Shunt Voltage Register contents by the decimal value of the Calibration Register and then dividing by 2048, as shown in [Equation 3](#). For this example, the Shunt Voltage Register contains a value of 8,000, which is multiplied by the Calibration Register value of 2560 and then divided by 2048 to yield a decimal value for the Current Register of 10000, or 2710h. Multiplying this value by 1mA/bit results in the original 10A level stated in the example.

$$\text{Current} = \frac{\text{ShuntVoltage} \cdot \text{CalibrationRegister}}{2048} \quad (3)$$

The LSB for the Bus Voltage Register (02h) is a fixed 1.25mV/bit, which means that the 11.98V present at the V_{BUS} pin results in a register value of 2570h, or a decimal equivalent of 9584. Note that the MSB of the Bus Voltage Register is always zero because the V_{BUS} pin is only able to measure positive voltages.

The Power Register (03h) is then be calculated by multiplying the decimal value of the Current Register, 10000, by the decimal value of the Bus Voltage Register, 9584, and then dividing by 20,000, as defined in Equation 4. For this example, the result for the Power Register is 12B8h, or a decimal equivalent of 4792. Multiplying this result by the power LSB (25 times the $[1 \times 10^{-3}$ Current LSB]) results in a power calculation of $(4792 \times 25\text{mW/bit})$, or 119.82W. The power LSB has a fixed ratio to the current LSB of 25W/bit to 1A/bit. For this example, a programmed 1mA/bit current LSB results in a power LSB of 25mW/bit. This ratio is internally programmed to ensure that the scaling of the power calculation is within an acceptable range. A manual calculation for the power being delivered to the load would use a bus voltage of 11.98V ($12V_{CM} - 20\text{mV}$ shunt drop) multiplied by the load current of 10A to give a result of 119.8W.

$$\text{Power} = \frac{\text{Current} \cdot \text{BusVoltage}}{20,000} \tag{4}$$

Table 1 shows the steps for configuring, measuring, and calculating the values for current and power for this device.

Table 1. Configure/Measure/Calculate Example⁽¹⁾

| STEP # | REGISTER NAME | ADDRESS | CONTENTS | DEC | LSB | VALUE |
|--------|---------------|---------|----------|-------|--------|---------|
| Step 1 | Configuration | 00h | 4127h | — | — | — |
| Step 2 | Shunt | 01h | 1F40h | 8000 | 2.5µV | 20mV |
| Step 3 | Bus | 02h | 2570h | 9584 | 1.25mV | 11.98V |
| Step 4 | Calibration | 05h | A00h | 2560 | — | — |
| Step 5 | Current | 04h | 2710 | 10000 | 1mA | 10A |
| Step 6 | Power | 03h | 12B8h | 4792 | 25mW | 119.82W |

(1) Conditions: Load = 10A, $V_{CM} = 12V$, $R_{SHUNT} = 2\text{m}\Omega$, and $V_{BUS} = 12V$.

PROGRAMMING THE INA226 POWER MEASUREMENT ENGINE

Calibration Register and Scaling

The Calibration Register makes it possible to set the scaling of the Current and Power Registers to whatever values are most useful for a given application. One strategy may be to set the Calibration Register such that the largest possible number is generated in the Current Register or Power Register at the expected full-scale point. This approach would yield the highest resolution based using the previously calculated minimum current LSB in the equation for the Calibration Register. The Calibration Register can also be selected to provide values in the Current and Power Registers that either provide direct decimal equivalents of the values being measured, or yield a round LSB value for each corresponding register. After these choices have been made, the Calibration Register also offers possibilities for end user system-level calibration. By physically measuring the current with an external ammeter, the exact current is known. The value of the Calibration Register can then be adjusted based on the measured current result of the INA226 to cancel the total system error as shown in Equation 5.

$$\text{Corrected_Full_Scale_Cal} = \text{trunc} \left[\frac{\text{Cal} \times \text{MeasShuntCurrent}}{\text{INA226_Current}} \right] \tag{5}$$

Simple Current Shunt Monitor Usage (No Programming Necessary)

The INA226 can be used without any programming if it is only necessary to read a shunt voltage drop and bus voltage with the default power-on reset configuration and continuous conversion of shunt and bus voltage.

Without programming the INA226 Calibration Register, the device is unable to provide either a valid current or power value, because these outputs are both derived using the values loaded into the Calibration Register.

Default INA226 Settings

The default power-up states of the registers are shown in the [INA226 Register Descriptions](#) section of this data sheet. These registers are volatile, and if programmed to a value other than the default values shown in [Table 2](#), they must be re-programmed at every device power-up. Detailed information on programming the Calibration Register specifically is given in the [Configure/Measure/Calculate Example](#) section and calculated based on [Equation 1](#).

REGISTER INFORMATION

The INA226 uses a bank of registers for holding configuration settings, measurement results, minimum/maximum limits, and status information. [Table 2](#) summarizes the INA226 registers; refer to [Figure 1](#) for an illustration of the registers.

Table 2. Summary of Register Set

| POINTER ADDRESS | REGISTER NAME | FUNCTION | POWER-ON RESET | | TYPE ⁽¹⁾ |
|-----------------|------------------------|---|-------------------|-------|---------------------|
| | | | BINARY | HEX | |
| 0 | Configuration Register | All-register reset, shunt voltage and bus voltage ADC conversion times and averaging, operating mode. | 01000001 00100111 | 4127 | R/W |
| 1 | Shunt Voltage | Shunt voltage measurement data. | 00000000 00000000 | 0000 | R |
| 2 | Bus Voltage | Bus voltage measurement data. | 00000000 00000000 | 0000 | R |
| 3 | Power ⁽²⁾ | Contains the value of the calculated power being delivered to the load. | 00000000 00000000 | 0000 | R |
| 4 | Current ⁽²⁾ | Contains the value of the calculated current flowing through the shunt resistor. | 00000000 00000000 | 0000 | R |
| 5 | Calibration | Sets full-scale range and LSB of current and power measurements. Overall system calibration. | 00000000 00000000 | 0000 | R/W |
| 6 | Mask/Enable | Alert configuration and conversion ready flag. | 00000000 00000000 | 0000 | R/W |
| 7 | Alert Limit | Contains the limit value to compare to the selected Alert function. | 00000000 00000000 | 0000 | R/W |
| FF | Die ID | Contains unique die identification number. | ASCII | ASCII | R |

(1) Type: R = Read-Only, R/W = Read/Write.

(2) The Current Register defaults to '0' because the Calibration Register defaults to '0', yielding a zero current and power value until the Calibration Register is programmed.

REGISTER DETAILS

All 16-bit INA226 registers are two 8-bit bytes via the I²C interface.

Configuration Register 00h (Read/Write)

| BIT # | D15 | D14 | D13 | D12 | D11 | D10 | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|-----------|-----|-----|-----|-----|------|------|------|----------------------|----------------------|----------------------|---------------------|---------------------|---------------------|-------|-------|-------|
| BIT NAME | RST | — | — | — | AVG2 | AVG1 | AVG0 | V _{BUS} CT2 | V _{BUS} CT1 | V _{BUS} CT0 | V _{SH} CT2 | V _{SH} CT1 | V _{SH} CT0 | MODE3 | MODE2 | MODE1 |
| POR VALUE | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | 1 | 0 | 0 | 1 | 1 | 1 |

The Configuration Register settings control the operating modes for the INA226. This register controls the conversion time settings for both the shunt and bus voltage measurements as well as the averaging mode used. The operating mode that controls what signals are selected to be measured is also programmed in the Configuration Register.

The Configuration Register can be read from at any time without impacting or affecting the device settings or a conversion in progress. Writing to the Configuration Register will halt any conversion in progress until the write sequence is completed resulting in a new conversion starting based on the new contents of the Configuration Register. This prevents any uncertainty in the conditions used for the next completed conversion.

Bit Descriptions

RST: **Reset Bit**

Bit 15 Setting this bit to '1' generates a system reset that is the same as power-on reset. Resets all registers to default values; this bit self-clears.

AVG: **Averaging Mode**

Bits 9–11 Sets the number of samples that will be collected and averaged together. [Table 3](#) summarizes the AVG bit settings and related number of averages for each bit.

Table 3. AVG Bit Settings[11:9]⁽¹⁾

| AVG2 D11 | AVG1 D10 | AVG0 D9 | NUMBER OF AVERAGES |
|-------------|-------------|------------|-----------------------|
| 0 | 0 | 0 | 1 |
| 0 | 0 | 1 | 4 |
| 0 | 1 | 0 | 16 |
| 0 | 1 | 1 | 64 |
| 1 | 0 | 0 | 128 |
| 1 | 0 | 1 | 256 |
| 1 | 1 | 0 | 512 |
| 1 | 1 | 1 | 1024 |

(1) Shaded values are default.

V_{BUS} CT:

Bits 6–8

Bus Voltage Conversion Time

 Sets the conversion time for the bus voltage measurement. [Table 4](#) shows the V_{BUS} CT bit options and related conversion times for each bit.

Table 4. V_{BUS} CT Bit Settings [8:6] ⁽¹⁾

| V _{BUS} CT2 D8 | V _{BUS} CT1 D7 | V _{BUS} CT0 D6 | CONVERSION TIME |
|----------------------------|----------------------------|----------------------------|-----------------|
| 0 | 0 | 0 | 140µs |
| 0 | 0 | 1 | 204µs |
| 0 | 1 | 0 | 332µs |
| 0 | 1 | 1 | 588µs |
| 1 | 0 | 0 | 1.1ms |
| 1 | 0 | 1 | 2.116ms |
| 1 | 1 | 0 | 4.156ms |
| 1 | 1 | 1 | 8.244ms |

(1) Shaded values are default.

V_{SH} CT:

Bits 3–5

Shunt Voltage Conversion Time

 Sets the conversion time for the shunt voltage measurement. [Table 5](#) shows the V_{SH} CT bit options and related conversion times for each bit.

Table 5. V_{SH} CT Bit Settings [5:3] ⁽¹⁾

| V _{SH} CT2 D5 | V _{SH} CT1 D4 | V _{SH} CT0 D3 | CONVERSION TIME |
|---------------------------|---------------------------|---------------------------|-----------------|
| 0 | 0 | 0 | 140µs |
| 0 | 0 | 1 | 204µs |
| 0 | 1 | 0 | 332µs |
| 0 | 1 | 1 | 588µs |
| 1 | 0 | 0 | 1.1ms |
| 1 | 0 | 1 | 2.116ms |
| 1 | 1 | 0 | 4.156ms |
| 1 | 1 | 1 | 8.244ms |

(1) Shaded values are default.

MODE:

Bits 0–2

Operating Mode

 Selects continuous, triggered, or power-down mode of operation. These bits default to continuous shunt and bus measurement mode. The mode settings are shown in [Table 6](#).

Table 6. Mode Settings [2:0] ⁽¹⁾

| MODE3 D2 | MODE2 D1 | MODE1 D0 | MODE |
|-------------|-------------|-------------|---------------------------|
| 0 | 0 | 0 | Power-Down |
| 0 | 0 | 1 | Shunt Voltage, Triggered |
| 0 | 1 | 0 | Bus Voltage, Triggered |
| 0 | 1 | 1 | Shunt and Bus, Triggered |
| 1 | 0 | 0 | Power-Down |
| 1 | 0 | 1 | Shunt Voltage, Continuous |
| 1 | 1 | 0 | Bus Voltage, Continuous |
| 1 | 1 | 1 | Shunt and Bus, Continuous |

(1) Shaded values are default.

DATA OUTPUT REGISTERS

Shunt Voltage Register 01h (Read-Only)

The Shunt Voltage Register stores the current shunt voltage reading, V_{SHUNT} . Negative numbers are represented in twos complement format. Generate the twos complement of a negative number by complementing the absolute value binary number and adding 1. Extend the sign, denoting a negative number by setting the MSB = '1'.

Example: For a value of $V_{SHUNT} = -80\text{mV}$:

1. Take the absolute value: 80mV
2. Translate this number to a whole decimal number ($80\text{mV} \div 2.5\mu\text{V}$) = 32000
3. Convert this number to binary = 111 1101 0000 0000
4. Complement the binary result = 000 0010 1111 1111
5. Add '1' to the complement to create the twos complement result = 000 0011 0000 0000
6. Extend the sign and create the 16-bit word: 1000 0011 0000 0000 = 8300h

If averaging is enabled, this register displays the averaged value. Full-scale range = 81.92mV (decimal = 7FFF); LSB: 2.5 μV .

| BIT # | D15 | D14 | D13 | D12 | D11 | D10 | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|-----------|------|------|------|------|------|------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| BIT NAME | SIGN | SD14 | SD13 | SD12 | SD11 | SD10 | SD9 | SD8 | SD7 | SD6 | SD5 | SD4 | SD3 | SD2 | SD1 | SD0 |
| POR VALUE | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

Bus Voltage Register 02h (Read-Only)⁽¹⁾

The Bus Voltage Register stores the most recent bus voltage reading, V_{BUS} .

If averaging is enabled, this register displays the averaged value. Full-scale range = 40.96V (decimal = 7FFF); LSB = 1.25mV.

| BIT # | D15 | D14 | D13 | D12 | D11 | D10 | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|-----------|-----|------|------|------|------|------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| BIT NAME | — | BD14 | BD13 | BD12 | BD11 | BD10 | BD9 | BD8 | BD7 | BD6 | BD5 | BD4 | BD3 | BD2 | BD1 | BD0 |
| POR VALUE | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

(1) D15 is always zero because bus voltage can only be positive.

Power Register 03h (Read-Only)

If averaging is enabled, this register displays the averaged value.

| BIT # | D15 | D14 | D13 | D12 | D11 | D10 | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|-----------|------|------|------|------|------|------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| BIT NAME | PD15 | PD14 | PD13 | PD12 | PD11 | PD10 | PD9 | PD8 | PD7 | PD6 | PD5 | PD4 | PD3 | PD2 | PD1 | PD0 |
| POR VALUE | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

The Power Register LSB is internally programmed to equal 25 times the programmed value of the Current_LSB.

The Power Register records power in watts by multiplying the decimal values of the current register with the decimal value of the bus voltage register according to [Equation 4](#).

Current Register 04h (Read-Only)

If averaging is enabled, this register displays the averaged value.

| BIT # | D15 | D14 | D13 | D12 | D11 | D10 | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|-----------|-------|------|------|------|------|------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| BIT NAME | CSIGN | CD14 | CD13 | CD12 | CD11 | CD10 | CD9 | CD8 | CD7 | CD6 | CD5 | CD4 | CD3 | CD2 | CD1 | CD0 |
| POR VALUE | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

The value of the Current Register is calculated by multiplying the decimal value in the Shunt Voltage Register with the decimal value of the Calibration Register, according to [Equation 3](#).

Calibration Register 05h (Read/Write)

This register provides the INA226 with the value of the shunt resistor that was present to create the measured differential voltage. It also sets the resolution of the Current Register. The current LSB and power LSB are set through the programming of this register. This register is also suitable for use in overall system calibration. See the [Configure/Measure/Calculate Example](#) for additional information on programming the Calibration Register.

| BIT # | D15 | D14 | D13 | D12 | D11 | D10 | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|-----------|-----|------|------|------|------|------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| BIT NAME | — | FS14 | FS13 | FS12 | FS11 | FS10 | FS9 | FS8 | FS7 | FS6 | FS5 | FS4 | FS3 | FS2 | FS1 | FS0 |
| POR VALUE | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

Mask/Enable 06h (Read/Write)

The Mask/Enable Register selects the function that is enabled to control the Alert pin, as well as how that pin functions. If multiple functions are enabled, the highest significant bit position Alert Function (D11-D15) takes priority and responds to the Alert Limit register.

| BIT # | D15 | D14 | D13 | D12 | D11 | D10 | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|-----------|-----|-----|-----|-----|-----|------|----|----|----|----|----|-----|------|-----|------|-----|
| BIT NAME | SOL | SUL | BOL | BUL | POL | CNVR | — | — | — | — | — | AFF | CVRF | OVF | APOL | LEN |
| POR VALUE | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

SOL: **Shunt Voltage Over-Voltage**

Bit 15 Setting this bit high configures the Alert pin to be asserted when the Shunt Voltage Register exceeds the value in the Alert Limit Register.

SUL: **Shunt Voltage Under-Voltage**

Bit 14 Setting this bit high configures the Alert pin to be asserted when the Shunt Voltage Register drops below the value in the Alert Limit Register.

BOL: **Bus Voltage Over-Voltage**

Bit 13 Setting this bit high configures the Alert pin to be asserted when the Bus Voltage Register exceeds the value in the Alert Limit Register.

BUL: **Bus Voltage Under-Voltage**

Bit 12 Setting this bit high configures the Alert pin to be asserted when the Bus Voltage Register drops below the value in the Alert Limit Register.

POL: **Over-Limit Power**

Bit 11 Setting this bit high configures the Alert pin to be asserted when the Power Register exceeds the value in the Alert Limit Register.

CNVR: **Conversion Ready**

Bit 10 Setting this bit high configures the Alert pin to be asserted when the Conversion Ready Flag, Bit 3, is asserted indicating that the device is ready for the next conversion.

- AFF:** **Alert Function Flag**
 Bit 4 While only one Alert Function can be monitored at the Alert pin at a time, the Conversion Ready can also be enabled to assert the Alert pin. Reading the Alert Function Flag following an alert allows the user to determine if the Alert Function was the source of the Alert.
 When the Alert Latch Enable bit is set to Latch mode, the Alert Function Flag clears only when the Mask/Enable Register is read. When the Alert Latch Enable bit is set to Transparent mode, the Alert Function Flag is cleared following the next conversion that does not result in an Alert condition.
- CVRF:** **Conversion Ready Flag**
 Bit 3 Although the INA226 can be read at any time, and the data from the last conversion is available, the Conversion Ready bit is provided to help coordinate one-shot or triggered conversions. The Conversion Ready bit is set after all conversions, averaging, and multiplications are complete. Conversion Ready clears under the following conditions:
 1.) Writing to the Configuration Register (except for Power-Down or Disable selections)
 2.) Reading the Mask/Enable Register
- OVF:** **Math Overflow Flag**
 Bit 2 This bit is set to '1' if an arithmetic operation resulted in an overflow error. It indicates that current and power data may be invalid.
- APOL:** **Alert Polarity bit; sets the Alert pin polarity.**
 Bit 1 1 = Inverted (active-high open collector)
 0 = Normal (active-low open collector) (default)
- LEN:** **Alert Latch Enable; configures the latching feature of the Alert pin and Flag bits.**
 Bit 0 1 = Latch enabled
 0 = Transparent (default)
 When the Alert Latch Enable bit is set to Transparent mode, the Alert pin and Flag bits will reset to their idle states when the fault has been cleared. When the Alert Latch Enable bit is set to Latch mode, the Alert pin and Flag bits will remain active following a fault until the Mask/Enable Register has been read.

Alert Limit 07h (Read/Write)

The Alert Limit Register contains the value used to compare to the register selected in the Mask/Enable Register to determine if a limit has been exceeded.

| BIT # | D15 | D14 | D13 | D12 | D11 | D10 | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|-----------|-------|-------|-------|-------|-------|-------|------|------|------|------|------|------|------|------|------|------|
| BIT NAME | AUL15 | AUL14 | AUL13 | AUL12 | AUL11 | AUL10 | AUL9 | AUL8 | AUL7 | AUL6 | AUL5 | AUL4 | AUL3 | AUL2 | AUL1 | AUL0 |
| POR VALUE | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

BUS OVERVIEW

The INA226 offers compatibility with both I²C and SMBus interfaces. The I²C and SMBus protocols are essentially compatible with one another.

The I²C interface is used throughout this data sheet as the primary example, with SMBus protocol specified only when a difference between the two systems is discussed. Two bidirectional lines, SCL and SDA, connect the INA226 to the bus. Both SCL and SDA are open-drain connections.

The device that initiates a data transfer is called a *master*, and the devices controlled by the master are *slaves*. The bus must be controlled by a master device that generates the serial clock (SCL), controls the bus access, and generates START and STOP conditions.

To address a specific device, the master initiates a start condition by pulling the data signal line (SDA) from a high to a low logic level while SCL is high. All slaves on the bus shift in the slave address byte on the rising edge of SCL, with the last bit indicating whether a read or write operation is intended. During the ninth clock pulse, the slave being addressed responds to the master by generating an Acknowledge and pulling SDA low.

Data transfer is then initiated and eight bits of data are sent, followed by an *Acknowledge* bit. During data transfer, SDA must remain stable while SCL is high. Any change in SDA while SCL is high is interpreted as a start or stop condition.

Once all data have been transferred, the master generates a stop condition, indicated by pulling SDA from low to high while SCL is high. The INA226 includes a 28ms timeout on its interface to prevent locking up the bus.

Serial Bus Address

To communicate with the INA226, the master must first address slave devices via a slave address byte. The slave address byte consists of seven address bits and a direction bit that indicates whether the action is to be a read or write operation.

The INA226 has two address pins, A0 and A1. [Table 7](#) describes the pin logic levels for each of the 16 possible addresses. The state of pins A0 and A1 is sampled on every bus communication and should be set before any activity on the interface occurs.

Table 7. INA226 Address Pins and Slave Addresses

| A1 | A0 | SLAVE ADDRESS |
|-----------------|-----------------|---------------|
| GND | GND | 1000000 |
| GND | V _{S+} | 1000001 |
| GND | SDA | 1000010 |
| GND | SCL | 1000011 |
| V _{S+} | GND | 1000100 |
| V _{S+} | V _{S+} | 1000101 |
| V _{S+} | SDA | 1000110 |
| V _{S+} | SCL | 1000111 |
| SDA | GND | 1001000 |
| SDA | V _{S+} | 1001001 |
| SDA | SDA | 1001010 |
| SDA | SCL | 1001011 |
| SCL | GND | 1001100 |
| SCL | V _{S+} | 1001101 |
| SCL | SDA | 1001110 |
| SCL | SCL | 1001111 |

Serial Interface

The INA226 operates only as a slave device on both the I²C bus and the SMBus. Connections to the bus are made via the open-drain I/O lines SDA and SCL. The SDA and SCL pins feature integrated spike suppression filters and Schmitt triggers to minimize the effects of input spikes and bus noise. While there is spike suppression integrated into the digital I/O lines, proper layout should be used to minimize the amount of coupling into the communication lines. This noise introduction could occur from capacitively coupling signal edges between the two communication lines themselves or from other switching noise sources present in the system. Routing traces in parallel with ground in between layers on a printed circuit board (PCB) typically reduces the effects of coupling between the communication lines. Shielding communication lines in general is recommended to reduce to possibility of unintended noise coupling into the digital I/O lines that could be incorrectly interpreted as start or stop commands.

The INA226 supports the transmission protocol for Fast (1kHz to 400kHz) and High-speed (1kHz to 3.4MHz) modes. All data bytes are transmitted most significant byte first.

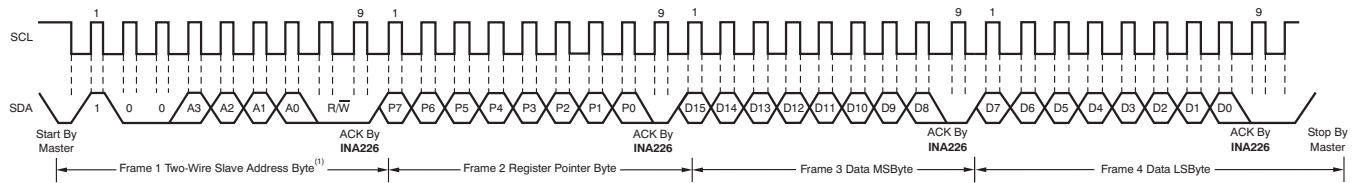
WRITING TO/READING FROM THE INA226

Accessing a specific register on the INA226 is accomplished by writing the appropriate value to the register pointer. Refer to [Table 2](#) for a complete list of registers and corresponding addresses. The value for the register pointer (as shown in [Figure 27](#)) is the first byte transferred after the slave address byte with the R/W bit low. Every write operation to the INA226 requires a value for the register pointer.

Writing to a register begins with the first byte transmitted by the master. This byte is the slave address, with the R/W bit low. The INA226 then acknowledges receipt of a valid address. The next byte transmitted by the master is the address of the register which data will be written to. This register address value updates the register pointer to the desired register. The next two bytes are written to the register addressed by the register pointer. The INA226 acknowledges receipt of each data byte. The master may terminate data transfer by generating a start or stop condition.

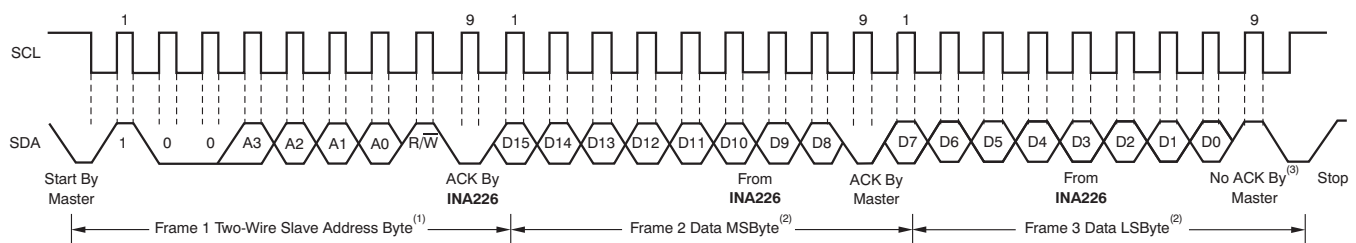
When reading from the INA226, the last value stored in the register pointer by a write operation determines which register is read during a read operation. To change the register pointer for a read operation, a new value must be written to the register pointer. This write is accomplished by issuing a slave address byte with the R/W bit low, followed by the register pointer byte. No additional data are required. The master then generates a start condition and sends the slave address byte with the R/W bit high to initiate the read command. The next byte is transmitted by the slave and is the most significant byte of the register indicated by the register pointer. This byte is followed by an *Acknowledge* from the master; then the slave transmits the least significant byte. The master acknowledges receipt of the data byte. The master may terminate data transfer by generating a *Not-Acknowledge* after receiving any data byte, or generating a start or stop condition. If repeated reads from the same register are desired, it is not necessary to continually send the register pointer bytes; the INA226 retains the register pointer value until it is changed by the next write operation.

[Figure 24](#) and [Figure 25](#) show the write and read operation timing diagrams, respectively. Note that register bytes are sent most-significant byte first, followed by the least significant byte.



(1) The value of the Slave Address byte is determined by the settings of the A0 and A1 pins. Refer to [Table 7](#).

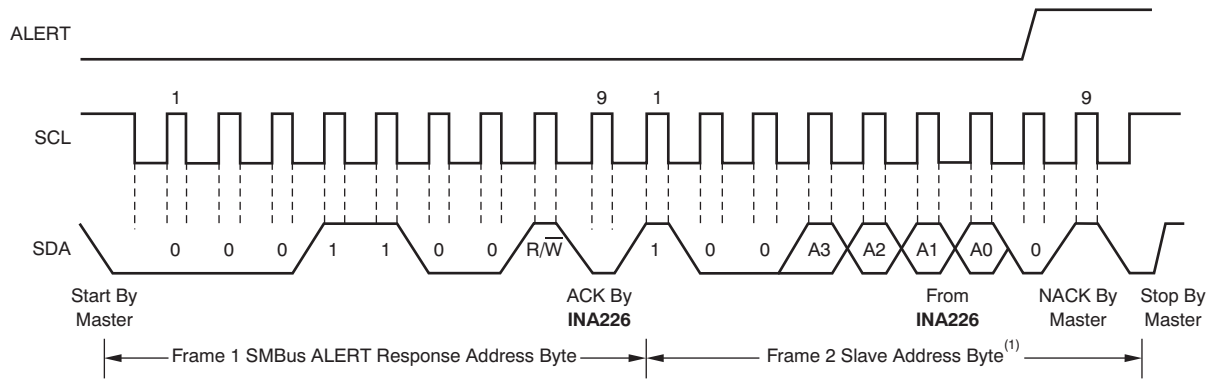
Figure 24. Timing Diagram for Write Word Format



- (1) The value of the Slave Address byte is determined by the settings of the A0 and A1 pins. Refer to [Table 7](#).
- (2) Read data is from the last register pointer location. If a new register is desired, the register pointer must be updated. See [Figure 23](#).
- (3) ACK by Master can also be sent.

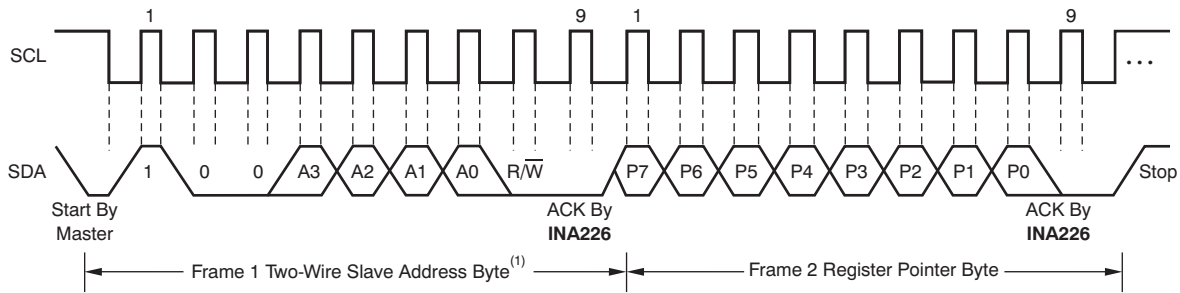
Figure 25. Timing Diagram for Read Word Format

Figure 26 shows the timing diagram for the SMBus Alert response operation. Figure 27 illustrates a typical register pointer configuration.



(1) The value of the Slave Address Byte is determined by the settings of the A0 and A1 pins. Refer to Table 7.

Figure 26. Timing Diagram for SMBus ALERT



(1) The value of the Slave Address Byte is determined by the settings of the A0 and A1 pins. Refer to Table 7.

Figure 27. Typical Register Pointer Set

High-Speed I²C Mode

When the bus is idle, both the SDA and SCL lines are pulled high by the pull-up devices. The master generates a start condition followed by a valid serial byte containing High-Speed (HS) master code 00001XXX. This transmission is made in fast (400kHz) or standard (100kHz) (F/S) mode at no more than 400kHz. The INA226 does not acknowledge the HS master code, but does recognize it and switches its internal filters to support 3.4MHz operation.

The master then generates a repeated start condition (a repeated start condition has the same timing as the start condition). After this repeated start condition, the protocol is the same as F/S mode, except that transmission speeds up to 3.4MHz are allowed. Instead of using a stop condition, repeated start conditions should be used to secure the bus in HS-mode. A stop condition ends the HS-mode and switches all the internal filters of the INA226 to support the F/S mode.

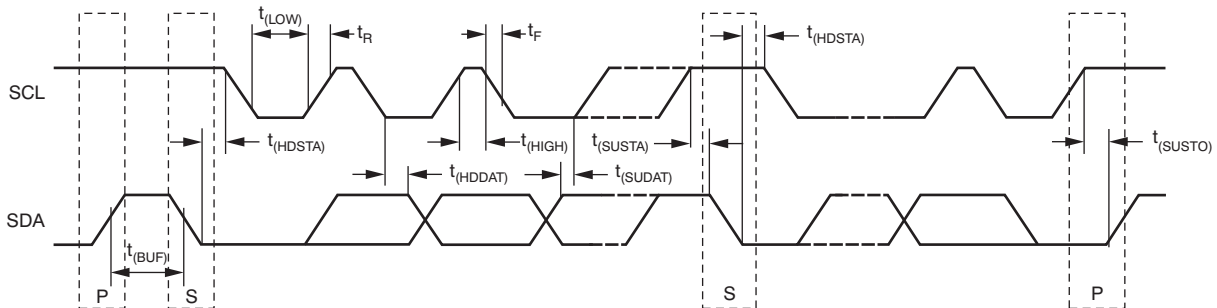


Figure 28. Bus Timing Diagram

Bus Timing Diagram Definitions

| PARAMETER | | FAST MODE | | HIGH-SPEED MODE | | UNITS |
|--|---------------|-----------|------|-----------------|-----|-------|
| | | MIN | MAX | MIN | MAX | |
| SCL operating frequency | $f_{(SCL)}$ | 0.001 | 0.4 | 0.001 | 3.4 | MHz |
| Bus free time between stop and start conditions | $t_{(BUF)}$ | 600 | | 160 | | ns |
| Hold time after repeated START condition. After this period, the first clock is generated. | $t_{(HDSTA)}$ | 100 | | 100 | | ns |
| Repeated start condition setup time | $t_{(SUSTA)}$ | 100 | | 100 | | ns |
| STOP condition setup time | $t_{(SUSTO)}$ | 100 | | 100 | | ns |
| Data hold time | $t_{(HDDAT)}$ | 0 | | 0 | | ns |
| Data setup time | $t_{(SUDAT)}$ | 100 | | 10 | | ns |
| SCL clock low period | $t_{(LOW)}$ | 1300 | | 160 | | ns |
| SCL clock high period | $t_{(HIGH)}$ | 600 | | 60 | | ns |
| Clock/data fall time | t_F | | 300 | | 160 | ns |
| Clock/data rise time | t_R | | 300 | | 160 | ns |
| Clock/data rise time for $SCLK \leq 100kHz$ | t_R | | 1000 | | | ns |

SMBus Alert Response

The INA226 is designed to respond to the SMBus Alert Response address. The SMBus Alert Response provides a quick fault identification for simple slave devices. When an Alert occurs, the master can broadcast the Alert Response slave address (0001 100) with the Read/Write bit set high. Following this Alert Response, any slave devices that generated an alert will identify themselves by acknowledging the Alert Response and sending their respective address on the bus.

The Alert Response can activate several different slave devices simultaneously, similar to the I²C General Call. If more than one slave attempts to respond, bus arbitration rules apply. The losing device does not generate an Acknowledge and continues to hold the Alert line low until the interrupt is cleared.

PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/ Ball Finish | MSL Peak Temp ⁽³⁾ | Samples (Requires Login) |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|----------------------|------------------------------|-----------------------------|
| INA226AIDGSR | ACTIVE | MSOP | DGS | 10 | 2500 | TBD | Call TI | Call TI | |
| INA226AIDGST | ACTIVE | MSOP | DGS | 10 | 250 | TBD | Call TI | Call TI | |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSELETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

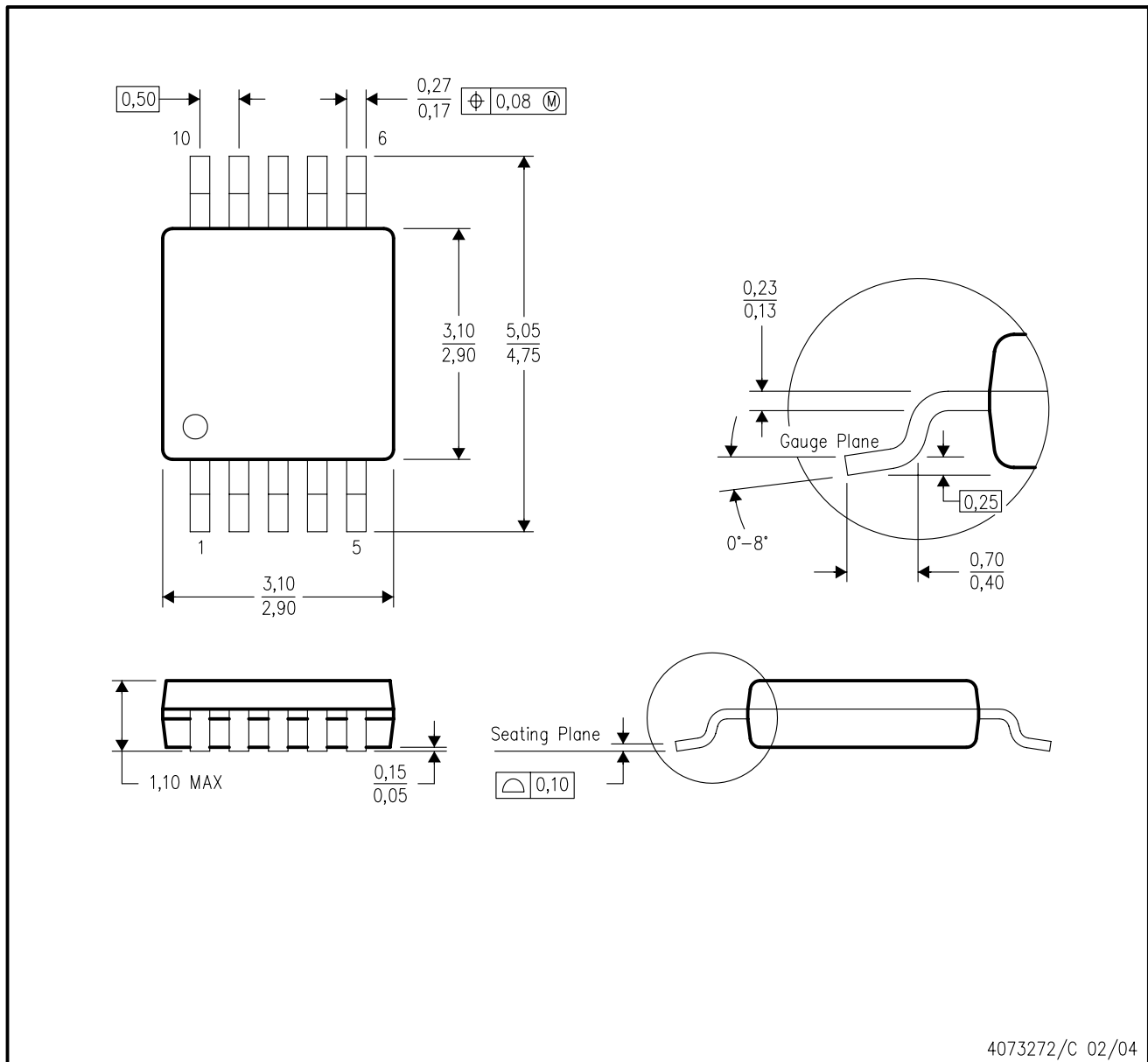
⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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DGS (S-PDSO-G10)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion.
 - D. Falls within JEDEC MO-187 variation BA.

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